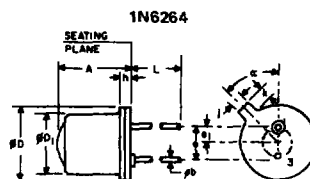


1N6264, 1N6265

Infrared Emitter Gallium Arsenide Infrared Emitting Diode

The 1N6264 and 1N6265 Series are gallium arsenide, light emitting diodes which emit non-coherent, infrared energy. They are ideally suited for use with silicon detectors. The 1N6264 has a lens which provides a narrow beam angle while the 1N6265 has a flat window for a wide beam angle which is useful with external lensing.



SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN.	MAX.	MIN.	MAX.	
A		.250		6.47	
gD	.016	.021	.407	.533	
gD1	.209	.230	5.31	5.84	
gD2	.180	.189	4.57	4.77	
e	.000NOM.		2.54NOM.		2
h	.050NOM.		1.27NOM.		2
i		.030		.76	
j	.031	.044	.79	1.11	
k	.036	.046	.92	1.16	1
L	1.00		25.4		
g		45°		45°	3

absolute maximum ratings: (25°C unless otherwise specified)

Voltages

† Reverse Voltage V_R 3 volts

Currents

† Forward Current (continuous) I_F 100 mA

† Forward Current (pw 1 μ s, 200 Hz) I_F 10 A

Dissipation

† Power Dissipation ($T_A = 25^\circ\text{C}$)* P_T 170 mW

Power Dissipation ($T_C = 25^\circ\text{C}$ ** P_T 1.3 W

Temperatures

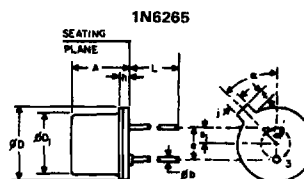
† Junction Temperature T_J -65 to +150 °C

† Storage Temperature T_{stg} -65 to +150 °C

† Lead Soldering Time (1/16" [1.6mm] from case for 10 sec.) T_L 260 °C

*Derate 1.36 mW/°C above 25°C ambient.

**Derate 10.4 mW/°C above 25°C case.



electrical characteristics: (25°C unless otherwise specified)

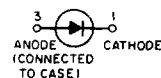
	SYM.	MIN.	TYP.	MAX.	UNITS
† Reverse Leakage Current ($V_R = 3V$)	I_R	—	—	10	μA
† Forward Voltage ($I_F = 100\text{ mA}$)	V_F	—	1.4	1.7	Volts
† Total Power Output (note 1) ($I_F = 100\text{ mA}$)	P_o	6	—	—	mW
† Peak Emission Wavelength ($I_F = 100\text{ mA}$)	λ_p	935	945	955	nm
Spectral Shift with Temperature		—	.28	—	nm/°C
† Spectral Bandwidth - 50%	$\Delta\lambda$	—	—	60	nm
† Half Intensity Beam Angle					
1N6264	θ_{HI}	—	—	20	deg
1N6265	θ_{HI}	—	—	80	deg
Rise Time - 0.90% of Output	t_r	—	1.0	—	μs
Fall Time - 100-10% of Output	t_f	—	1.0	—	μs

Note 1:

Total power output, P_o , is the total power radiated by the device into a solid angle of 2π steradians.

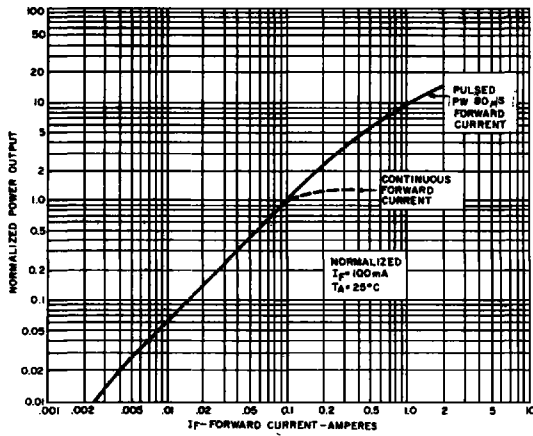
† Indicates JEDEC registered values.

SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN.	MAX.	MIN.	MAX.	
A		.155		3.93	
gD	.016	.021	.407	.533	
gD1	.209	.230	5.31	5.84	
gD2	.180	.187	4.57	4.77	
e	.000NOM.		2.54NOM.		2
h	.050NOM.		1.27NOM.		2
i		.050		.76	
j	.031	.044	.79	1.11	
k	.036	.046	.92	1.16	1
L	1.00		25.4		
g		45°		45°	3

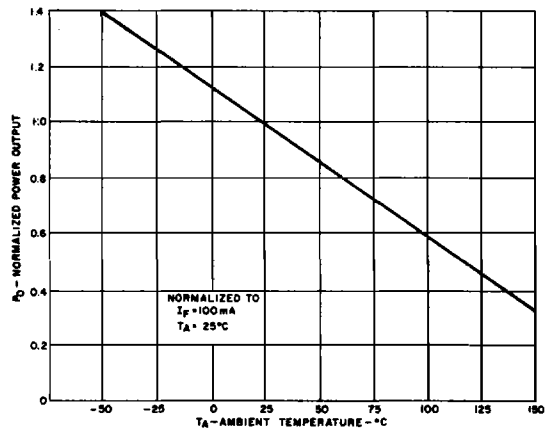


1. Measured from maximum diameter of device.
2. Leads having max. diameter .021" (.533mm) measured in gaging plane .054" + .001" - .000 (1.37 + 0.25 - 0.00mm) below the reference plane of the device shall be within .007" (.178mm) their true position relative to a maximum width tab.
3. From centerline tab.

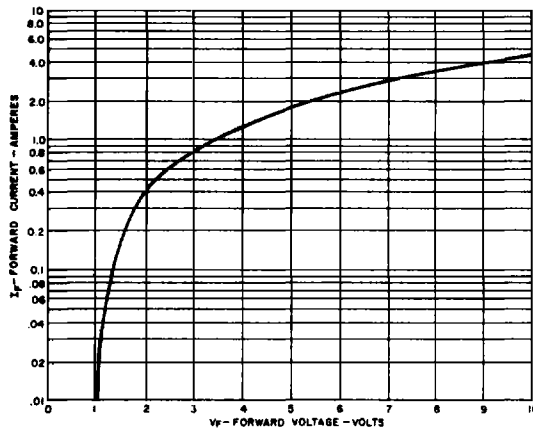
TYPICAL CHARACTERISTICS



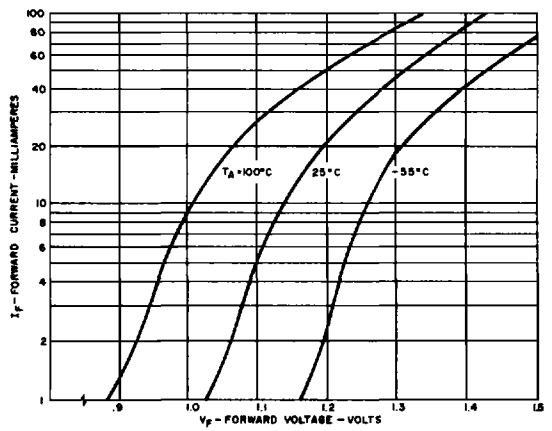
1. POWER OUTPUT VS. INPUT CURRENT



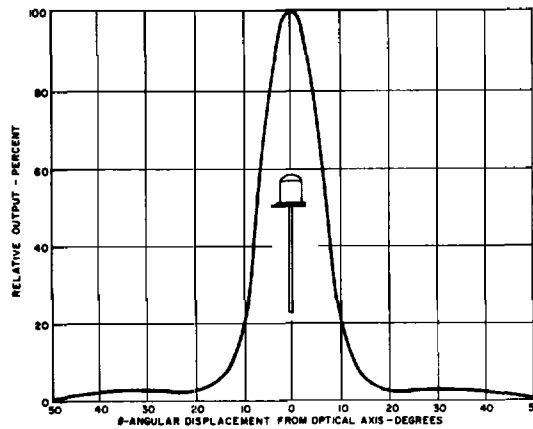
2. POWER OUTPUT VS. TEMPERATURE



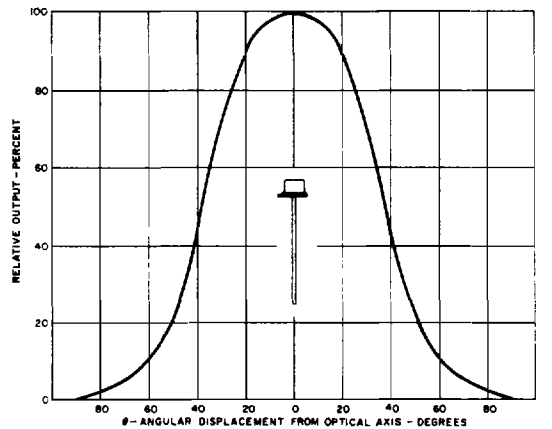
3. FORWARD VOLTAGE VS. FORWARD CURRENT



4. FORWARD VOLTAGE VS. FORWARD CURRENT



5. 1N6264 - TYPICAL RADIATION PATTERN



6. 1N6265 - TYPICAL RADIATION PATTERN

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